

HCS-T MICRO C C C C 7035 - Electronics housing



2203124

<https://www.phoenixcontact.com/us/products/2203124>

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Handheld housing, T-Micro, light gray, consisting of two half shells with screws, front level, closed

Your advantages

- Suitable for handheld devices
- Easy integration of LCD displays and membrane keypads
- Ergonomic straight or staggered housing design
- Fast mounting, thanks to the modular design

Commercial data

Item number	2203124
Packing unit	1 pc
Minimum order quantity	1 pc
Sales key	AC02
Product key	ACFABA
GTIN	4055626376820
Weight per piece (including packing)	99.4 g
Weight per piece (excluding packing)	99.4 g
Customs tariff number	84879090
Country of origin	DE

2203124

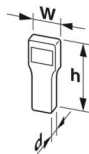
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Technical data

Product properties

Product type	Complete housing
Housing series	HCS
Type	straight
Housing type	Handheld housing
Ventilation openings present	no
Battery compartment	no

Dimensions

Dimensional drawing	
Width	48 mm
Height	150 mm
Depth	28 mm

PCB design

PCB thickness	1.4 mm ... 1.8 mm
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Material specifications

Color (Housing)	light grey (RAL 7035)
Flammability rating according to UL 94	V0
CTI according to IEC 60112	$400 \leq \text{CTI} < 600$
Insulating material	II
Surface characteristics	untreated
Housing material	ABS

Environmental and real-life conditions

Glow-wire test

Specification	IEC 60695-2-11:2014-02
Temperature	850 °C
Time of exposure	30 s

Thermal stability / ball thrust test

Specification	IEC 60695-10-2:2014-02
Temperature	80 °C
Test duration	1 h
Force	20

Degree of protection (IP code)

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Specification	IEC 60529:1989-11 + AMD 1:1999-11 + AMD 2:2013-08
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Ambient conditions

Max. IP code to attain	IP54
Ambient temperature (operation)	-40 °C ... 80 °C (depending on power dissipation)
Ambient temperature (storage/transport)	-40 °C ... 55 °C
Ambient temperature (assembly)	-5 °C ... 80 °C
Relative humidity (storage/transport)	95 %

PCB data

Number of PCB holders	2
Thickness of the PCB	1.4 mm ... 1.8 mm

Packaging specifications

Type of packaging	Box packaging
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Classifications

ECLASS

ECLASS-11.0	27182702
ECLASS-13.0	27190102

ETIM

ETIM 9.0	EC001031
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UNSPSC

UNSPSC 21.0	31261500
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Phoenix Contact USA
586 Fulling Mill Road
Middletown, PA 17057, United States
(+717) 944-1300
info@phoenixcon.com